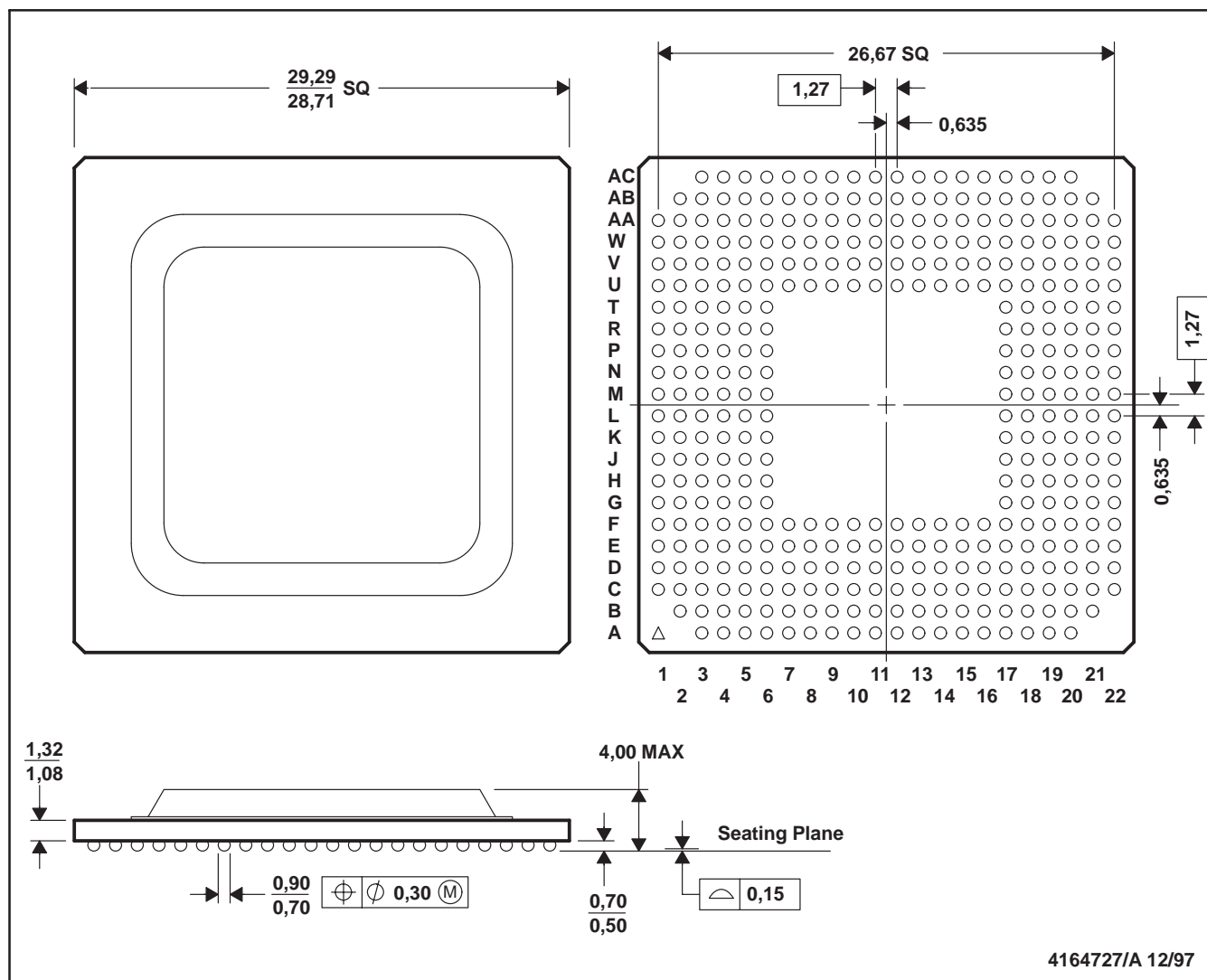


GLG (S-CBGA-N372)

CERAMIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a metal lid.

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